

**KK74AC651**

## Octal 3-State Bus Transceivers and D Flip-Flops

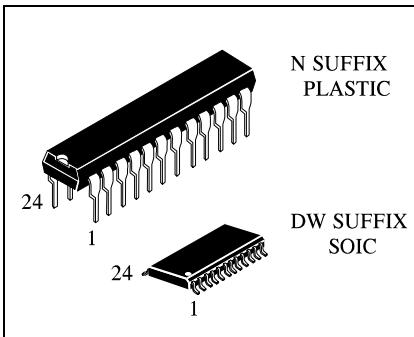
### High-Speed Silicon-Gate CMOS

The KK74AC651 is identical in pinout to the LS/ALS651, HC/HCT651. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALS outputs.

These devices consists of bus transceiver circuits, D-type flip-flop, and control circuitry arranged for multiplex transmission of data directly from the data bus or from the internal storage registers. Direction and Output Enable are provided to select the read-time or stored data function. Data on the A or B Data bus, or both, can be stored in the internal D flip-flops by low-to-high transitions at the appropriate clock pins (A-to-B Clock or B-to-A Clock) regardless of the select or enable or enable control pins. When A-to-B Source and B-to-A Source are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling Direction and Output Enable. In this configuration each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

The KK74AC651 has inverted outputs.

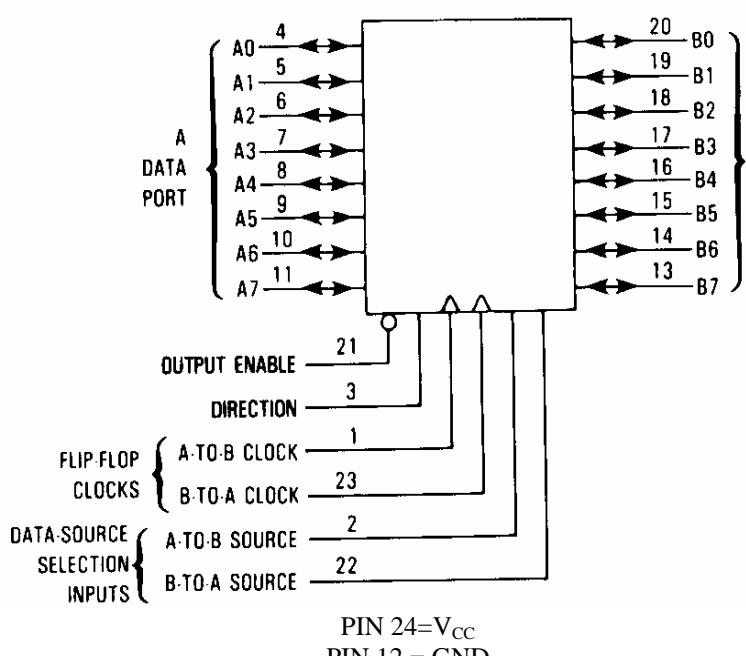
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0  $\mu$ A, 0.1  $\mu$ A @ 25°C
- High Noise Immunity Characteristic of CMOS Devices
- Outputs Source/Sink 24 mA

**ORDERING INFORMATION**

KK74AC651N Plastic  
KK74AC651DW SOIC  
 $T_A = -40^\circ$  to  $85^\circ$  C for all packages

**PIN ASSIGNMENT**

|               |     |    |                 |
|---------------|-----|----|-----------------|
| A-TO-B CLOCK  | 1 ● | 24 | V <sub>CC</sub> |
| A-TO-B SOURCE | 2   | 23 | B-TO-A CLOCK    |
| DIRECTION     | 3   | 22 | B-TO-A SOURCE   |
| A0            | 4   | 21 | OUTPUT          |
| A1            | 5   | 20 | ENABLE          |
| A2            | 6   | 19 | B0              |
| A3            | 7   | 18 | B1              |
| A4            | 8   | 17 | B2              |
| A5            | 9   | 16 | B3              |
| A6            | 10  | 15 | B4              |
| A7            | 11  | 14 | B5              |
| GND           | 12  | 13 | B6              |
|               |     |    | B7              |

**LOGIC DIAGRAM**

### **MAXIMUM RATINGS\***

| Symbol           | Parameter   | Value                        | Unit |
|------------------|---|------------------------------|------|
| V <sub>CC</sub>  | DC Supply Voltage (Referenced to GND)   | -0.5 to +7.0                 | V    |
| V <sub>IN</sub>  | DC Input Voltage (Referenced to GND)  | -0.5 to V <sub>CC</sub> +0.5 | V    |
| V <sub>OUT</sub> | DC Output Voltage (Referenced to GND)   | -0.5 to V <sub>CC</sub> +0.5 | V    |
| I <sub>IN</sub>  | DC Input Current, per Pin   | ±20                          | mA   |
| I <sub>OUT</sub> | DC Output Sink/Source Current, per Pin  | ±50                          | mA   |
| I <sub>CC</sub>  | DC Supply Current, V <sub>CC</sub> and GND Pins                               | ±50                          | mA   |
| P <sub>D</sub>   | Power Dissipation in Still Air, Plastic DIP+ SOIC Package+                    | 750<br>500                   | mW   |
| T <sub>tsg</sub> | Storage Temperature   | -65 to +150                  | °C   |
| T <sub>L</sub>   | Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package) | 260                          | °C   |

\*Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C

SOIC Package: : - 7 mW/°C from 65° to 125°C

### **RECOMMENDED OPERATING CONDITIONS**

| Symbol                             | Parameter   | Min  | Max             | Unit            |      |
|------------------------------------|---|--|-----------------|-----------------|------|
| V <sub>CC</sub>                    | DC Supply Voltage (Referenced to GND)                 | 2.0  | 6.0             | V               |      |
| V <sub>IN</sub> , V <sub>OUT</sub> | DC Input Voltage, Output Voltage (Referenced to GND)  | 0  | V <sub>CC</sub> | V               |      |
| T <sub>J</sub>                     | Junction Temperature (PDIP)                           |  | 140             | °C              |      |
| T <sub>A</sub>                     | Operating Temperature, All Package Types              | -40  | +85             | °C              |      |
| I <sub>OH</sub>                    | Output Current - High                                 |  | -24             | mA              |      |
| I <sub>OL</sub>                    | Output Current - Low                                  |  | 24              | mA              |      |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time *<br>(except Schmitt Inputs) | V <sub>CC</sub> =3.0 V<br>V <sub>CC</sub> =4.5 V<br>V <sub>CC</sub> =5.5 V | 0<br>0<br>0     | 150<br>40<br>25 | ns/V |

\* V<sub>IN</sub> from 30% to 70% V<sub>CC</sub>

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V<sub>IN</sub> and V<sub>OUT</sub> should be constrained to the range GND≤(V<sub>IN</sub> or V<sub>OUT</sub>)≤V<sub>CC</sub>.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

**DC ELECTRICAL CHARACTERISTICS** (Voltages Referenced to GND)

| Symbol           | Parameter                                      | Test Conditions  | V <sub>CC</sub><br>V | Guaranteed Limits    |                      | Unit |
|------------------|--|--|----------------------|----------------------|----------------------|------|
|                  |  |  |                      | 25 °C                | -40°C to<br>85°C     |      |
| V <sub>IH</sub>  | Minimum High-Level Input Voltage               | V <sub>OUT</sub> =0.1 V or V <sub>CC</sub> -0.1 V  | 3.0<br>4.5<br>5.5    | 2.1<br>3.15<br>3.85  | 2.1<br>3.15<br>3.85  | V    |
| V <sub>IL</sub>  | Maximum Low - Level Input Voltage              | V <sub>OUT</sub> =0.1 V or V <sub>CC</sub> -0.1 V  | 3.0<br>4.5<br>5.5    | 0.9<br>1.35<br>1.65  | 0.9<br>1.35<br>1.65  | V    |
| V <sub>OH</sub>  | Minimum High-Level Output Voltage              | I <sub>OUT</sub> ≤ -50 μA  | 3.0<br>4.5<br>5.5    | 2.9<br>4.4<br>5.4    | 2.9<br>4.4<br>5.4    | V    |
|                  |  | *V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> =-12 mA<br>I <sub>OH</sub> =-24 mA<br>I <sub>OH</sub> =-24 mA          | 3.0<br>4.5<br>5.5    | 2.56<br>3.86<br>4.86 | 2.46<br>3.76<br>4.76 |      |
| V <sub>OL</sub>  | Maximum Low-Level Output Voltage               | I <sub>OUT</sub> ≤ 50 μA   | 3.0<br>4.5<br>5.5    | 0.1<br>0.1<br>0.1    | 0.1<br>0.1<br>0.1    | V    |
|                  |  | *V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> =12 mA<br>I <sub>OL</sub> =24 mA<br>I <sub>OL</sub> =24 mA             | 3.0<br>4.5<br>5.5    | 0.36<br>0.36<br>0.36 | 0.44<br>0.44<br>0.44 |      |
| I <sub>IN</sub>  | Maximum Input Leakage Current                  | V <sub>IN</sub> =V <sub>CC</sub> or GND  | 5.5                  | ±0.1                 | ±1.0                 | μA   |
| I <sub>OZ</sub>  | Maximum Three-State Leakage Current            | V <sub>IN</sub> (OE)=V <sub>IH</sub> or V <sub>IL</sub><br>V <sub>IN</sub> =V <sub>CC</sub> or GND<br>V <sub>OUT</sub> =V <sub>CC</sub> or GND | 5.5                  | ±0.6                 | ±6.0                 | μA   |
| I <sub>OLD</sub> | +Minimum Dynamic Output Current                | V <sub>OLD</sub> =1.65 V Max   | 5.5                  |                      | 75                   | mA   |
| I <sub>OHD</sub> | +Minimum Dynamic Output Current                | V <sub>OHD</sub> =3.85 V Min   | 5.5                  |                      | -75                  | mA   |
| I <sub>CC</sub>  | Maximum Quiescent Supply Current (per Package) | V <sub>IN</sub> =V <sub>CC</sub> or GND  | 5.5                  | 8.0                  | 80                   | μA   |

\* All outputs loaded; thresholds on input associated with output under test.

+Maximum test duration 2.0 ms, one output loaded at a time.

Note: I<sub>IN</sub> and I<sub>CC</sub> @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V<sub>CC</sub>

**AC ELECTRICAL CHARACTERISTICS (C<sub>L</sub>=50pF, Input t<sub>r</sub>=t<sub>f</sub>=3.0 ns)**

| Symbol           | Parameter  | V <sub>CC</sub> <sup>*</sup><br>V | Guaranteed Limits |              |                  |              | Unit |  |
|------------------|--|-----------------------------------|-------------------|--------------|------------------|--------------|------|--|
|                  |  |                                   | 25 °C             |              | -40°C to<br>85°C |              |      |  |
|                  |  |                                   | Min               | Max          | Min              | Max          |      |  |
| t <sub>PLH</sub> | Propagation Delay, A-to-B Clock or B-to-A Clock to A or B Data Port (Figure 1)   | 3.3<br>5.0                        | 4.0<br>2.5        | 17.0<br>12.0 | 3.0<br>2.0       | 19.0<br>14.0 | ns   |  |
| t <sub>PHL</sub> | Propagation Delay, A-to-B Clock or B-to-A Clock to A or B Data Port (Figure 1)   | 3.3<br>5.0                        | 3.0<br>2.0        | 14.5<br>10.5 | 2.5<br>1.5       | 16.5<br>12.0 | ns   |  |
| t <sub>PLH</sub> | Propagation Delay, Input A to Output B or Input B to Output A (Figures 2,3)      | 3.3<br>5.0                        | 3.0<br>2.0        | 14.0<br>9.5  | 2.5<br>1.5       | 16.0<br>11.0 | ns   |  |
| t <sub>PHL</sub> | Propagation Delay, Input A to Output B or Input B to Output A (Figures 2,3)      | 3.3<br>5.0                        | 2.5<br>1.5        | 13.0<br>9.0  | 2.0<br>1.0       | 15.0<br>10.5 | ns   |  |
| t <sub>PLH</sub> | Propagation Delay, A-to-B Source or B-to-A Source to A or B Data Port (Figure 4) | 3.3<br>5.0                        | 3.0<br>2.5        | 14.0<br>10.0 | 2.5<br>2.0       | 16.0<br>11.5 | ns   |  |
| t <sub>PHL</sub> | Propagation Delay, A-to-B Source or B-to-A Source to A or B Data Port (Figure 4) | 3.3<br>5.0                        | 2.5<br>2.0        | 13.5<br>10.0 | 2.0<br>1.5       | 15.5<br>11.5 | ns   |  |
| t <sub>PZH</sub> | Propagation Delay, Output Enable to A Data Port (Figure 5)                       | 3.3<br>5.0                        | 2.5<br>1.5        | 12.0<br>9.0  | 2.0<br>1.0       | 13.5<br>10.0 | ns   |  |
| t <sub>PZL</sub> | Propagation Delay, Output Enable to A Data Port (Figure 5)                       | 3.3<br>5.0                        | 2.5<br>1.5        | 12.0<br>9.0  | 2.0<br>1.0       | 14.0<br>10.5 | ns   |  |
| t <sub>PHZ</sub> | Propagation Delay, Output Enable to A Data Port (Figure 5)                       | 3.3<br>5.0                        | 3.0<br>2.0        | 13.0<br>11.0 | 2.5<br>1.5       | 14.0<br>12.0 | ns   |  |
| t <sub>PLZ</sub> | Propagation Delay, Output Enable to A Data Port (Figure 5)                       | 3.3<br>5.0                        | 2.5<br>2.0        | 12.5<br>10.5 | 2.0<br>1.5       | 14.0<br>12.0 | ns   |  |
| t <sub>PZH</sub> | Propagation Delay, Direction to B Data Port (Figure 6)                           | 3.3<br>5.0                        | 3.0<br>2.0        | 12.5<br>9.5  | 2.5<br>1.5       | 14.0<br>10.5 | ns   |  |
| t <sub>PZL</sub> | Propagation Delay, Direction to B Data Port (Figure 6)                           | 3.3<br>5.0                        | 2.5<br>1.5        | 12.5<br>9.5  | 2.0<br>1.0       | 14.5<br>11.0 | ns   |  |
| t <sub>PHZ</sub> | Propagation Delay, Direction to B Data Port (Figure 6)                           | 3.3<br>5.0                        | 3.5<br>2.5        | 13.5<br>11.5 | 3.0<br>2.0       | 14.5<br>12.5 | ns   |  |
| t <sub>PLZ</sub> | Propagation Delay, Direction to B Data Port (Figure 6)                           | 3.3<br>5.0                        | 3.0<br>2.5        | 13.5<br>11.5 | 2.5<br>2.0       | 15.0<br>13.0 | ns   |  |
| C <sub>IN</sub>  | Maximum Input Capacitance  | 5.0                               | 4.5               |              | 4.5              |              | pF   |  |
| C <sub>OUT</sub> | Input/Output Capacitance   | 5.0                               | 15                |              | 15               |              | pF   |  |

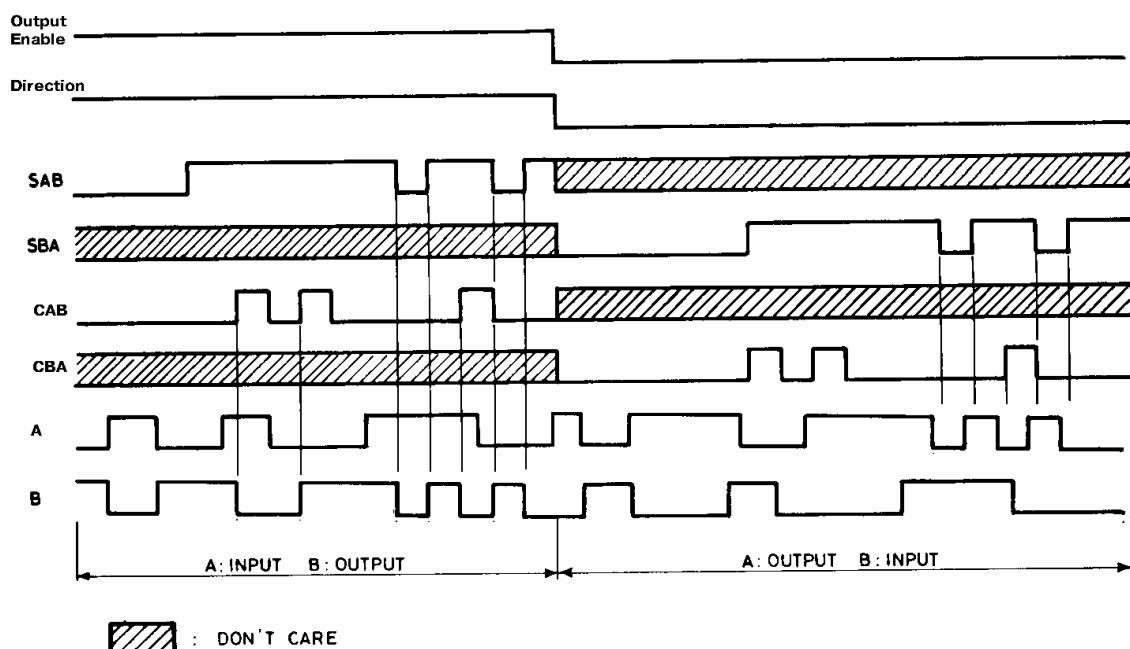
| C <sub>PD</sub> | Power Dissipation Capacitance | Typical @25°C, V <sub>CC</sub> =5.0 V |  | pF |
|-----------------|-------------------------------|---------------------------------------|--|----|
|                 |                               | 60                                    |  |    |

\*Voltage Range 3.3 V is 3.3 V ±0.3 V

Voltage Range 5.0 V is 5.0 V ±0.5 V

**TIMING REQUIREMENTS (C<sub>L</sub>=50pF, Input t<sub>r</sub>=t<sub>f</sub>=3.0 ns)**

| Symbol          | Parameter   | V <sub>CC</sub> <sup>*</sup><br>V | Guaranteed Limits |                  | Unit |
|-----------------|---|-----------------------------------|-------------------|------------------|------|
|                 |   |                                   | 25 °C             | -40°C to<br>85°C |      |
| t <sub>su</sub> | Minimum Setup Time, A or B Data Port to A-to-B Clock or B-to-A Clock (Figure 7) | 5.0                               | 7.0               | 8.0              | ns   |
| t <sub>h</sub>  | Minimum Hold Time, A-to-B Clock or B-to-A Clock to A or B Data Port (Figure 7)  | 5.0                               | 2.5               | 2.5              | ns   |
| t <sub>w</sub>  | Minimum Pulse Width, A-to-B Clock or B-to-A Clock (Figure 7)                    | 5.0                               | 6.0               | 7.0              | ns   |

**TIMING DIAGRAM**

**FUNCTION TABLE**

| Dir. | OE | CAB | CBA | SAB | SBA | A       | B       | FUNCTION  |
|------|----|-----|-----|-----|-----|---------|---------|---|
| L    | H  |     |     |     |     | INPUTS  | INPUTS  | Both the A bus and the B bus are inputs.  |
|      |    | X   | X   | X   | X   | Z       | Z       | The output functions of the A and B bus are disabled.   |
|      |    | ↑   | ↑   | X   | X   | INPUTS  | INPUTS  | Both the A and B bus are used for inputs to the internal flip-flops. Data at the bus will be stored on low to high transition of the clock inputs.                            |
| L    | L  |     |     |     |     | OUTPUTS | INPUTS  | The A bus are outputs and the B bus are inputs.   |
|      |    | X*  | X   | X   | L   | H<br>L  | L<br>H  | The data at the B bus are displayed at the A bus.   |
|      |    | X*  | ↑   | X   | L   | H<br>L  | L<br>H  | The data at the B bus are displayed at the A bus. The data of the B bus are stored to the internal flip-flops on low to high transition of the clock pulse.                   |
|      |    | X*  | X   | X   | H   | Qn      | X       | The data stored to the internal flip-flops, are displayed at the A bus.   |
|      |    | X*  | ↑   | X   | H   | L<br>H  | H<br>L  | The data at the B bus are stored to the internal flip-flops on low to high transition of the clock pulse. The states of the internal flip-flops output directly to the A bus. |
| H    | H  |     |     |     |     | INPUTS  | OUTPUTS | The A bus are inputs and the B bus are outputs.   |
|      |    | X   | X*  | L   | X   | H<br>L  | L<br>H  | The data at the A bus are displayed at the B bus.   |
|      |    | ↑   | X*  | L   | X   | H<br>L  | L<br>H  | The data at the B bus are displayed at the A bus. The data of the B bus are stored to the internal flip-flops on low to high transition of the clock pulse.                   |
|      |    | X   | X*  | H   | X   | X       | Qn      | The data stored to the internal flip-flops are displayed at the B bus.  |
|      |    | ↑   | X*  | H   | X   | H<br>L  | L<br>H  | The data at the A bus are stored to the internal flip-flops on low to high transition of the clock pulse. The states of the internal flip-flops output directly to the B bus. |
| H    | L  |     |     |     |     | OUTPUTS | OUTPUTS | Both the A bus and the B bus are outputs  |
|      |    | X   | X   | H   | H   | Qn      | Qn      | The data stored to the internal flip-flops are displayed at the A and B bus respectively.   |
|      |    | ↑   | ↑   | H   | H   | Qn      | Qn      | The output at the A bus are displayed at the B bus, the output at the B bus are displayed at the A bus respec.  |

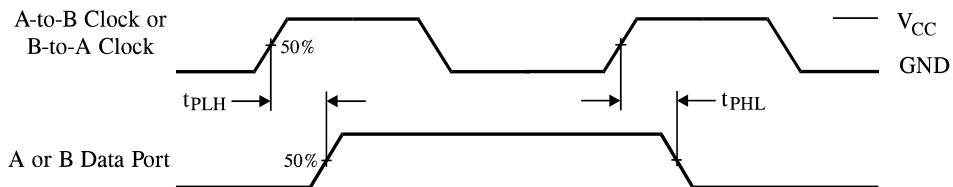
X : DON'T CARE

Z : HIGH IMPEDANCE

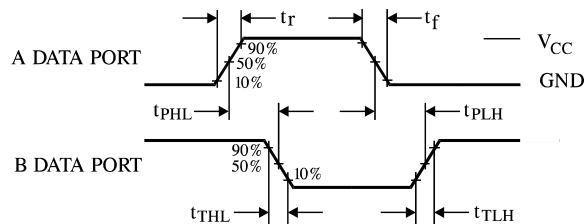
Qn : THE DATA STORED TO THE INTERNAL FLIP-FLOPS BY MOST RECENT LOW TO HIGH TRANSITION OF THE CLOCK INPUTS

\* : THE DATA AT THE A AND B BUS WILL BE STORED TO THE INTERNAL FLIP-FLOPS ON EVERY LOW TO TRANSITION OF THE CLOCK INPUTS

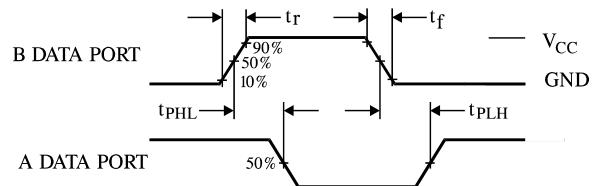
### SWITCHING DIAGRAMS



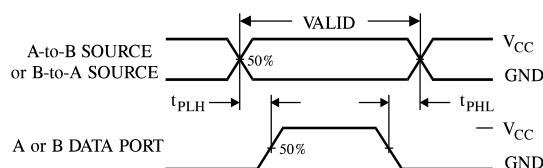
**Figure 1. Switching Waveforms**



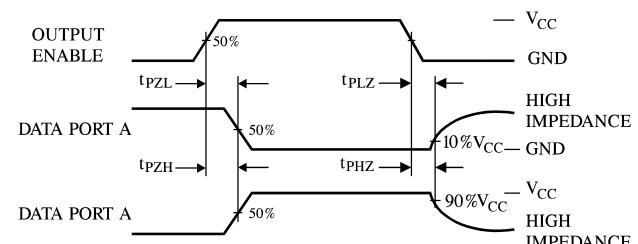
**Figure 2. A Data Port = Input, B Data Port = Output**



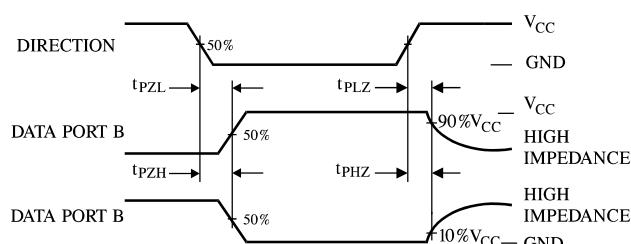
**Figure 3. A Data Port = Output, B Data Port = Input**



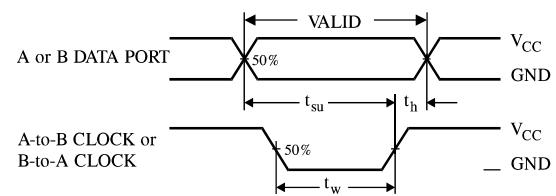
**Figure 4. Switching Waveforms**



**Figure 5. Switching Waveforms**

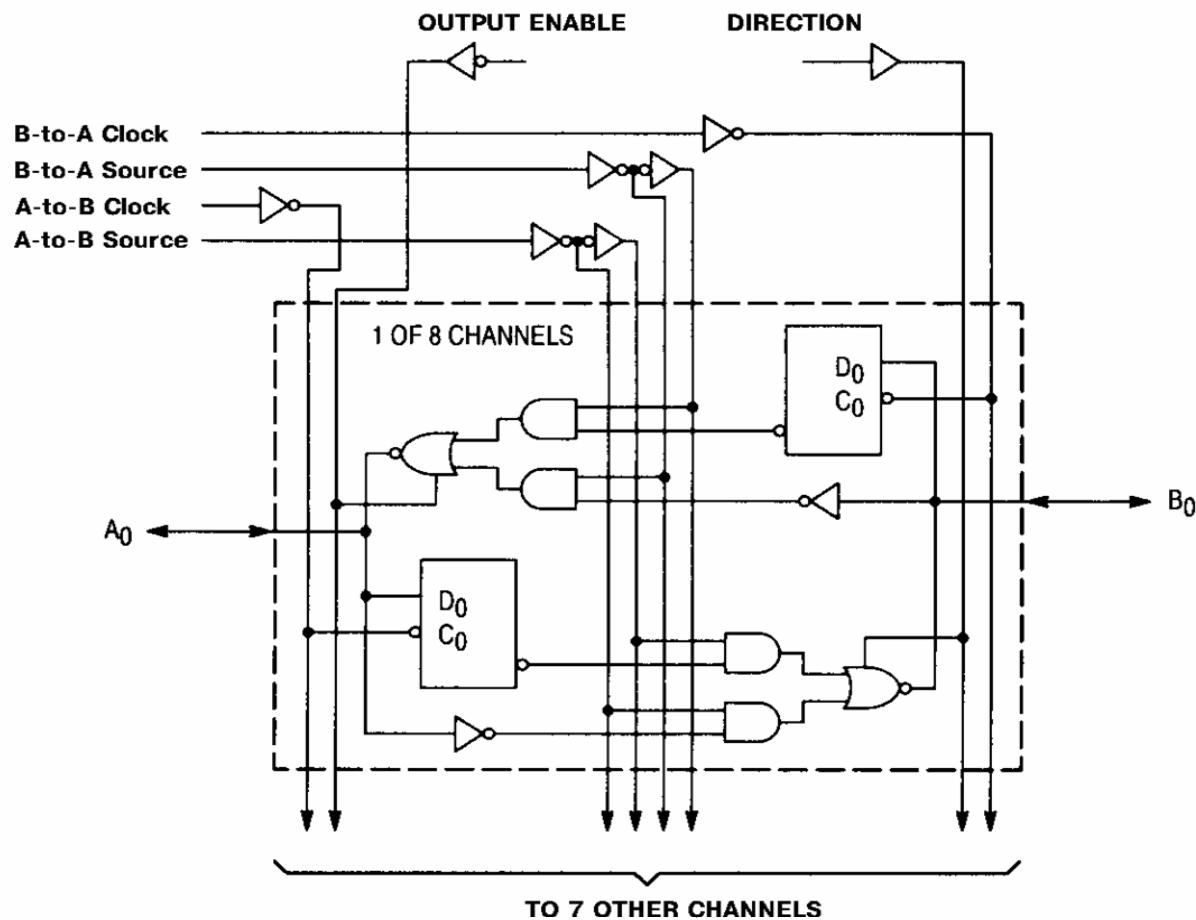


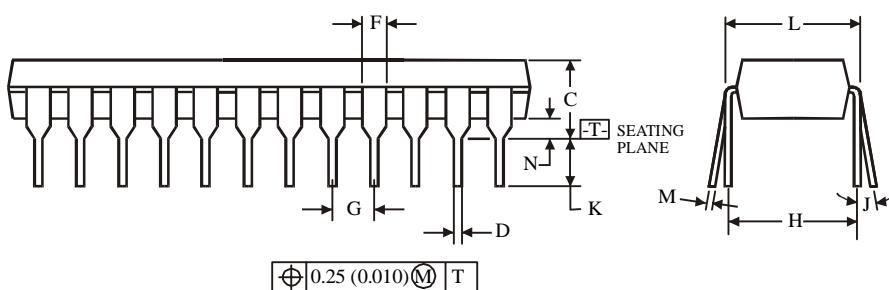
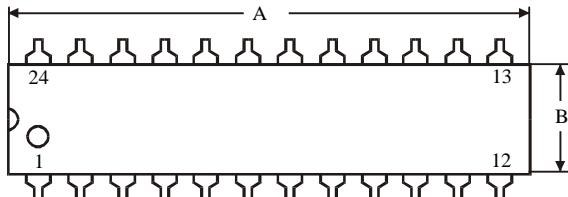
**Figure 6. Switching Waveforms**



**Figure 7. Switching Waveforms**

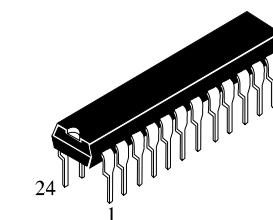
**EXPANDED LOGIC DIAGRAM**



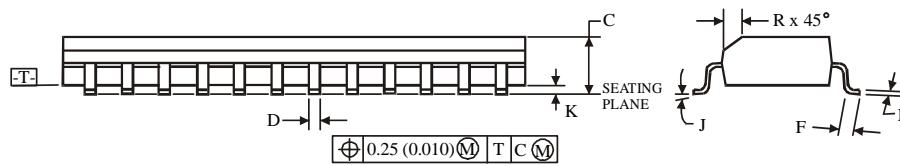
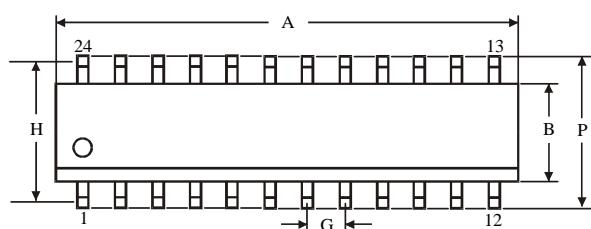
**N SUFFIX PLASTIC DIP  
(MS - 001AF)**

**NOTES:**

- Dimensions "A", "B" do not include mold flash or protrusions.

Maximum mold flash or protrusions 0.25 mm (0.010) per side.



|        | Dimension, mm |       |
|--------|---------------|-------|
| Symbol | MIN           | MAX   |
| A      | 31.24         | 32.51 |
| B      | 6.1           | 7.11  |
| C      |               | 5.33  |
| D      | 0.36          | 0.56  |
| F      | 1.14          | 1.78  |
| G      | 2.54          |       |
| H      | 7.62          |       |
| J      | 0°            | 10°   |
| K      | 2.92          | 3.81  |
| L      | 7.62          | 8.26  |
| M      | 0.2           | 0.36  |
| N      | 0.38          |       |

**D SUFFIX SOIC  
(MS - 013AD)**


|        | Dimension, mm |       |
|--------|---------------|-------|
| Symbol | MIN           | MAX   |
| A      | 15.2          | 15.6  |
| B      | 7.4           | 7.6   |
| C      | 2.35          | 2.65  |
| D      | 0.33          | 0.51  |
| F      | 0.4           | 1.27  |
| G      | 1.27          |       |
| H      | 9.53          |       |
| J      | 0°            | 8°    |
| K      | 0.1           | 0.3   |
| M      | 0.23          | 0.32  |
| P      | 10            | 10.65 |
| R      | 0.25          | 0.75  |

**NOTES:**

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.